# CPI1008K1R2R-10

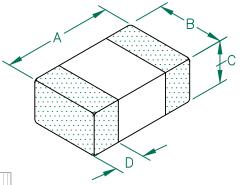
### PHYSICAL DIMENSIONS:

± 0.20[.008] A 2.50 [.098]

± 0.20[.008] B 2.00 [.079]

C 0.90 [.035] ± 0.10[.004]

± 0.20[.008] D 0.60 [.024]

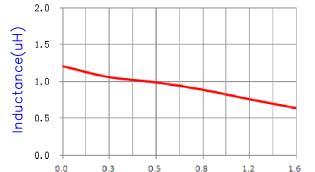


	ELECTRICAL CHARACTERISTICS:									
	L (μΗ) @ 1MHz ± 20%	DCR ( $\Omega$ )	l (Max)							
Nom	1.20									
Min	0.96									
Max	1.44	0.1375	1600mA							

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS REEL, EMBOSSED PLASTIC TAPE.
- 2. TERMINATION FINISH IS 100% MATTE Sn OVER Ni.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. I (MAX.) IS BASED ON THE MAXIMUM SUSTAINED CURRENT APPLIED WHILE MAINTAINING A MAXIMUM TEMPERATURE RISE OF 40°C OVER AMBIENT.
- 5. OPERATION TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)
- 6. COSMETIC SPECIFICATION REFER TO WI-QA-124.

## Ls vs Frequency 3.0 Inductance(uH) 2.5 1.0 0.5 1,000 Frequency (MHz)



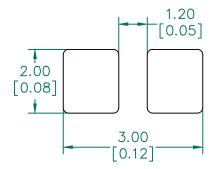
0.0

0.3

Ls vs DC BIAS Current

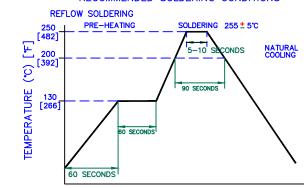
DC BIAS Current (A)

### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [0.030] to this dimension)

#### RECOMMENDED SOLDERING CONDITIONS





1.6

	DIMENSIONS ARE IN mm [INCHE	This print is the property of Lair										
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				rights to design or invention are								
				reserved.								
D	CHANGE DCR	07/13/17	QIU	PROJECT/PART NUMBER:	Т	_	PART T	PE:	DRAWN BY:			
С	UPDATE PAD DIMENSION ROHS	07/08/14	_	CPI1008K1R2R-10	-	D	CO-FIRE		QU			
В	UPDATE LAIRD LOGO AND NOTES 5	08/05/13	QU	DATE: 03/01/11	SCA	LE: NTC		SHEET:	<u> </u>			
Α	ORIGINAL DRAFT	03/01/11	OIL	, ,		NTS						
REV	DESCRIPTION	DATE	INT			~ -		1 of 1				